

ALT6720

HELP4[™] E800 (Band 20) LTE Linear PAM Data Sheet - Rev 2.3

FEATURES

- LTE Compliant
- 4th Generation HELP™ technology
- High Efficiency (LTE MPR = 0 dB):
 - 36 % @ Pout = +27.5 dBm
 - 23 % @ Pout = +16 dBm
 - 16 % @ Pout = +7 dBm
- · Low Quiescent Current: 3 mA
- Low Leakage Current in Shutdown Mode: <5 μA
- Internal Voltage Regulator
- Integrated "daisy chainable" directional coupler with CPLIN and CPLOUT port.
- Internal DC block on IN/OUT RF ports
- Optimized for a 50 Ω System
- 1.8 V Control Logic
- RoHS Compliant Package, 260 °C MSL-3

M45 Package 10 Pin 3 mm x 3 mm x 1 mm Surface Mount Module

APPLICATIONS

· Band 20 LTE Wireless Devices

PRODUCT DESCRIPTION

The ALT6720 HELP4™ PA is a 4th generation HELP™ product for LTE devices operating in E800 MHz Band 20. This PA incorporates ANADIGICS' HELP4™ technology to deliver exceptional efficiency at low power levels and low guiescent current without the need for external voltage regulators or converters. The device is manufactured using advanced InGaP-Plus™ HBT technology offering state-of-the-art reliability, temperature stability, and ruggedness. Three selectable bias modes that optimize efficiency for different output power levels and a shutdown mode with low leakage current increase handset talk and standby time. A "daisy chainable" directional coupler is integrated in the module, thus eliminating the need of an external coupler. The self-contained 3 mm x 3 mm x 1 mm surface mount package incorporates matching networks optimized for output power, efficiency, and linearity in a 50 Ω system.

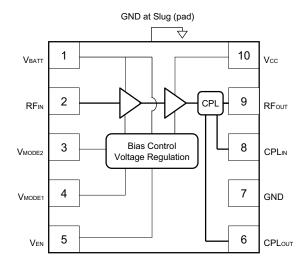


Figure 1: Block Diagram

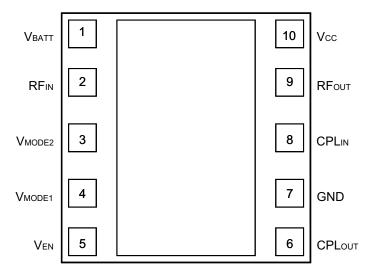


Figure 2: Pinout (X-ray Top View)

Table 1: Pin Description

PIN	NAME	DESCRIPTION		
1	V_{BATT}	Battery Voltage		
2	RFℕ	RF Input		
3	V _{MODE2}	Mode Control Voltage 2		
4	V _{MODE1}	Mode Control Voltage 1		
5	V_{EN}	PA Enable Voltage		
6	СРLоит	Coupler Output		
7	GND	Ground		
8	CPLℕ	Coupler Input		
9	RFоит	RF Output		
10	Vcc	Supply Voltage		

ELECTRICAL CHARACTERISTICS

Table 2: Absolute Minimum and Maximum Ratings

PARAMETER	MIN	MAX	UNIT
Supply Voltage (Vcc)	0	+5.0	V
Battery Voltage (VBATT)	0	+6	V
Control Voltages (VMODE1, VMODE2, VEN)	0	+3.5	V
RF Input Power (Pℕ)	-	+10	dBm
Storage Temperature (Tstg)	-40	+150	°C

Stresses in excess of the absolute ratings may cause permanent damage. Functional operation is not implied under these conditions. Exposure to absolute ratings for extended periods of time may adversely affect reliability.

Table 3: Operating Ranges

			9 :90		
PARAMETER	MIN	TYP	MAX	UNIT	COMMENTS
Operating Frequency (f)	832	-	862	MHz	
Supply Voltage (Vcc)	+3.1	+3.4	+4.35	٧	Pouт ≤ +27.5 dBm
Enable Voltage (V _{EN})	+1.35 0	+1.8	+3.1 +0.5	V	PA "on" PA "shut down"
Mode Control Voltage (V _{MODE1} ,V _{MODE2})	+1.35 0	+1.8 -	+3.1 +0.5	٧	Low Bias Mode High Bias Mode
LTE/UMTS Output Power (1, 2, 3) LTE (MPR=0), HPM LTE (MPR=0), MPM LTE (MPR=0), LPM	26.7 - -	27.5 16.0 7.0		dBm	TS 36.101 Rel 8
Case Temperature (Tc)	-40	-	+90	°C	

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

Notes:

⁽¹⁾ LTE waveform characteristics up to 20 MHz QPSK, 18 RB's.

⁽²⁾ For 3.1 V operation Pout derated 0.8 dB.

⁽³⁾ For operation at +105 °C, Pout is derated by 1.0 dB.

Table 4: Electrical Specifications - LTE Operation (MPR = 0 waveform, 10 MHz QPSK, 12 RB's) $(T_c = +25 \, ^{\circ}\text{C}, \, V_{cc} = +3.4 \, \text{V}, \, V_{BATT} = +3.4 \, \text{V}, \, V_{EN} = +1.8 \, \text{V}, \, 50 \, \Omega \, \text{system})$

		TYP	MAX	UNIT	COMMENTS			
PARAMETER	MIN				Роит	V _{MODE1}	V _{MODE2}	
Gain	27.5 17 10	30 20 13	33.5 23 16	dB	+27.5 dBm +16 dBm +7 dBm	0 V 1.8 V 1.8 V	0 V 0 V 1.8 V	
LTE to LTE, E-UTRA	1 1 1	-39 -39 -40	-35 -35 -35	dBc	+27.5 dBm +16 dBm +7 dBm	0 V 1.8 V 1.8 V	0 V 0 V 1.8 V	
UTRA ACLR1	1 1 1	-40 -39 -41	-36 -36 -36	dBc	+27.5 dBm +16 dBm +7 dBm	0 V 1.8 V 1.8 V	0 V 0 V 1.8 V	
UTRA ACLR2	1 1 1	-60 -60 -60	-40 -40 -40	dBc	+27.5 dBm +16 dBm +7 dBm	0 V 1.8 V 1.8 V	0 V 0 V 1.8 V	
Power-Added Efficiency (1)	32 19 13	36 23 16		%	+27.5 dBm +16 dBm +7 dBm	0 V 1.8 V 1.8 V	0 V 0 V 1.8 V	
Quiescent Current (lcq) Low Bias Mode	-	2.5	4	mA	through Vcc pin	1.8 V	1.8 V	
Mode Control Current	-	0.07	0.15	mA	through V _{MODE} pins, V _{MODE1,2} = +1.8 V			
Enable Current	-	0.03	0.1	mA	through V _{EN} pin			
BATT Current	•	0.8	1.5	mA	through V _{BATT} pin, V	through V_{BATT} pin, $V_{MODE1,2} = +1.8 \text{ V}$		
Leakage Current	1	<5	10	μA	$V_{BATT} = +4.35 \text{ V}, V_{CC} = +4.35 \text{ V}, \\ V_{EN} = 0 \text{ V}, V_{MODE1,2} = 0 \text{ V}$			
Noise Power	1 1 1	-132 -138 -143		dBm/Hz	791 - 821 MHz GPS Band, 1574 - 1577 MHz ISM Band, 2400 - 2483.5 MHz			
Harmonics 2fo 3fo, 4fo	1 1	-50 -62	-	dBc	Роит < +27.5 dBm			
Coupling Factor	-	20.5	-	dB				
Directivity	-	20	-	dB				
Daisy Chain Insertion Loss	-	<0.3	-	dB	698 - 2620 MHz Pin 8 through 9, shutdown mode		ode	
Spurious Output Level (all spurious outputs)	-	-	-70	dBc	Pout < +27.5 dBm In-band load VSWF Out-of-band load V Applies over all ope	SWR < 1		
Load mismatch stress with no permanent degradation or failure	8:1	-	-	VSWR	Applies over full op	erating ra	inge	

Notes:

(1) ACLR and Efficiency measured at 847 MHz.

APPLICATION INFORMATION

To ensure proper performance, refer to all related Application Notes on the ANADIGICS web site: http://www.anadigics.com

Shutdown Mode

The power amplifier may be placed in a shutdown mode by applying logic low levels (see Operating Ranges table) to the Ven, VMODE1 and VMODE2 voltages.

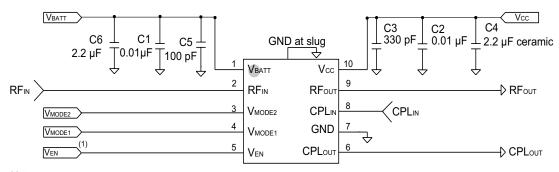
Bias Modes

The power amplifier may be placed in either Low, Medium or High Bias modes by applying the appropriate logic level (see Operating Ranges table) to the V_{MODE} pins. The Bias Control table below lists the recommended modes of operation for various applications.

Three operating modes are recommended to optimize current consumption. High Bias/High Power operating mode is for Pout levels \geq 16 dBm. At ~16 dBm - 7 dBm, the PA could be switched to Medium Power Mode. For Pout levels \leq ~7 dBm, the PA could be switched to Low Power Mode for extremely low current consumption.

Table 5: Bias Control

	_						
APPLICATION	Pout LEVELS	BIAS MODE	VEN	V MODE1	V _{MODE2}	Vcc	V BATT
Low power (Low Bias Mode)	≤ +7 dBm	Low	+1.8 V	+1.8 V	+1.8 V	3.2 - 4.35 V	> 3.2 V
Med power (Medium Bias Mode)	≥ +7 dBm ≤ +16 dBm	Low	+1.8 V	+1.8 V	0 V	3.2 - 4.35 V	> 3.2 V
High power (High Bias Mode)	≥ +16 dBm	High	+1.8 V	0 V	0 V	3.2 - 4.35 V	> 3.2 V
Shutdown	-	Shutdown	0 V	0 V	0 V	3.2 - 4.35 V	> 3.2 V

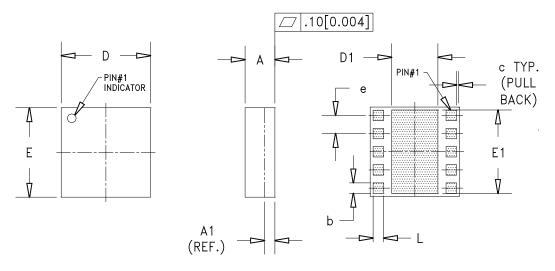


Notes:

(1) Rise and Fall time on V_{EN} Control Signal must be $\leq 1.0 \ \mu S$.

Figure 3: Evaluation Board Schematic

PACKAGE OUTLINE



S _{YMBOL}	MI	MILLIMETERS			INCHES			
-OL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
Α	0.91	1.03	1.13	0.035	0.041	0.044	-	
A1	PLEASE REFER TO LAMINATE CONTROL DRAWING							
b	0.32	0.35	0.40	0.013	0.014	0.016	3	
С	-	0.10	_	_	0.004	_	_	
D	2.88	3.00	3.12	0.113	0.118	0.123	-	
D1	1.45	1.50	1.57	0.057	0.059	0.062	3	
E	2.88	3.00	3.12	0.113	0.118	0.123	_	
E1	2.70	2.75	2.85	0.106	0.108	0.112	3	
е		0.60			0.024		3	
L	0.32	0.35	0.40	0.013	0.014	0.016	3	

NOTES:

- 1. CONTROLLING DIMENSIONS: MILLIMETERS
- 1. CONTROLLING DIMENSIONS: MILLIMETERS
 2. UNLESS SPECIFIED TOLERANCE=±0.076[0.003].
 3. PADS (INCLUDING CENTER) SHOWN UNIFORM SIZE FOR REFERENCE ONLY.
 ACTUAL PAD SIZE AND LOCATION WILL VARY WITHIN MIN. AND MAX. DIMENSIONS ACCORDING TO SPECIFIC LAMINATE DESIGN.
 4. UNLESS SPECIFIED DIMENSIONS ARE SYMMETRICAL ABOUT CENTER LINES SHOWN.
- 5. LAMINATE CONTROL DRAWING SPECIFIED BY PART NUMBER.

Figure 4: M45 Package Outline - 10 Pin 3 mm x 3 mm x 1 mm Surface Mount Module

TOP BRAND

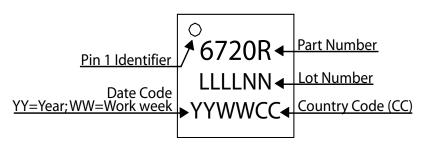
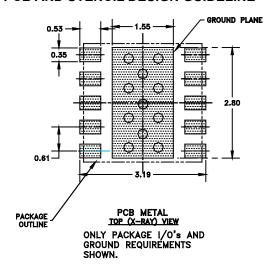


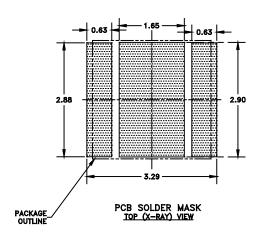
Figure 5: Branding Specification - M45 Package

PCB AND STENCIL DESIGN GUIDELINE



NOTES:

- (1) OUTLINE DRAWING REFERENCE: P8002478 E
- (2) UNLESS SPECIFIED DIMENSIONS
 ARE SYMMETRICAL ABOUT CENTER
 LINES SHOWN.
- (3) DIMENSIONS IN MILLIMETERS.
- (4) VIAS SHOWN IN PCB METAL VIEW ARE FOR REFERENCE ONLY.
 NUMBER & SIZE OF THERMAL VIAS REQUIRED DEPENDENT ON HEAT DISSIPATION REQUIREMENT AND THE PCB PROCESS CAPABILITY.
- (5) RECOMMENDED STENCIL THICKNESS: APPROX. 0.150mm (6 Mils)



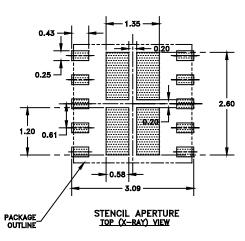
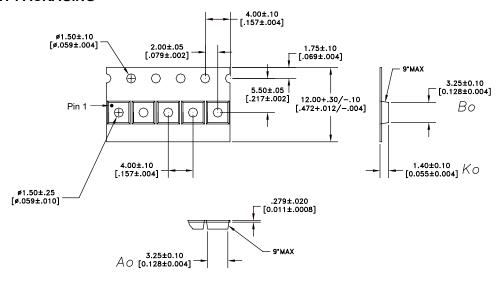


Figure 6: Recommended PCB Layout Information

COMPONENT PACKAGING



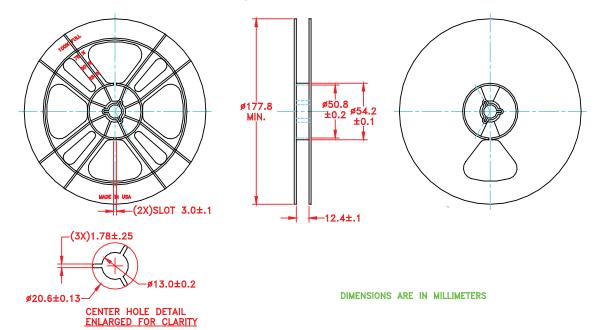
NOTES:

DIMENSIONS ARE IN MILLIMETERS [INCHES]

1. MATERIAL: 3000 (CARBON FILLED POLYCARBONATE) 100% RECYCLABLE.

DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994

Figure 7: Carrier Tape



NOTES:

1. MATERIAL: BLACK CARBON POLYSTYRENE
SURFACE RESISTIVITY: 1X10⁴TO 1X10⁸ ohms/square

DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994

Table 8: Reel

ALT6720

ORDERING INFORMATION

ORDER NUMBER TEMPERATURE RANGE		PACKAGE DESCRIPTION	COMPONENT PACKAGING	
ALT6720RM45Q7	-40 °C to +90 °C	RoHS Compliant 10 Pin 3 mm x 3 mm x 1 mm Surface Mount Module	Tape and Reel, 2500 pieces per Reel	
ALT6720RM45P9	-40 °C to +90 °C	RoHS Compliant 10 Pin 3 mm x 3 mm x 1 mm Surface Mount Module	Partial Tape and Reel	



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